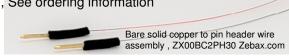
Product Description: ZX122S1AP is PCISIG M.2 power measurement module providing access to PCISIG M.2 power supply rails for purpose of characterizing, test & measurement of PCISIG M.2 supply voltages

Measure and analyze power supply ripple, transients, Device Under Test, DUT, power consumption and more.

- a) Each power supply rail is designed with current sensing power resistor, please see block diagram.
- b) Utilizing scope probe test equipment, measure power supply noise, ripples, transients, and DUT power consumption.
- c) Utilizing eLoad (Electronic Load), qualify host's power supply & maximum output power.
- d) Identify power supply trace impedance, Rdc , for improved Host / DUT PCB design.

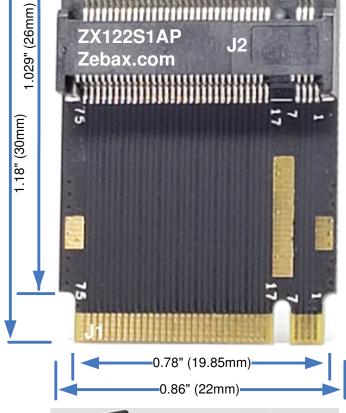
ZX122S1AP features:

- 1- Pass through PCISIG signals enabling real-time power supply test and measurement.
- 2- Onboard current sense resistors for all supply rails Please see table 1 for details.
- 3- All other traces are pass through designed for 50 Ohms impedance controlled.
- 4- Four layers PCB design, inner layers are GND planes + Exposed copper on top and bottom fill
- 5- Accessible GND exposed copper, enabling for ease of probe access for test and measurement.
- 6- Mates with any key matching M.2 Host and Device / DUT
- 7- The module is shipped with 12pc of probing wires, ZX00BC2PH30, See ordering information









Electrical:

Ε

Insertion loss > -2dB @6GHz Trace impedance: 50Ω

Operating Temperature: -65 °C to +170 °C

M.2 Edge Connector type (J1): Key A Mates with: M.2 Kev A

Plating: Gold 100U M.2 Receptacle (J2): Key Type: Key A

Height: 0.16" (4.2mm)

Spacer: 0.1" (2.54mm) - See Figure 3 Plating: Gold 100U

Current per pin: 0.5A (maximum)

Current Sense:

R1, R2: $10m\Omega$ 2512 SMD 7W - Thickness: 0.02" (0.5mm) Max - See Figure 3

Ratings: AEC-Q200

Temperature Coefficient: ±75ppm / °C

associated PCISIG M.2 connector assignment

PCISIG M.2 Connector pin

number

2. 4

72, 74

Operating Temperature:-65°C to +85°C at 100% listed power rating, see Table 1 -65 °C to +170 °C see section Power Rating on page 3

PCISIG M.2 Supply Rai

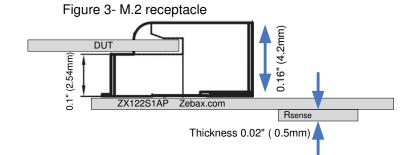
Table 1 lists onboard ZX122S1AP current sense resistors and

Shunt:

Current Sense resistors:

Current Sense Resistor

Package: 0402 SMD



Package

(mm)

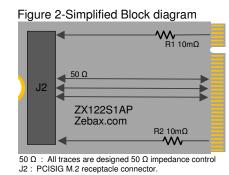
6432

6432

(inch)

2512

2512



Block diagram

Figure 1 – ZX122S1AP



Compliance:

ISO2001 certified RoHs - Lead Free EU RoHS2

UL E111594 document ELV- Vehicle Directive (Directive 2000/EC)

European Union Directive (203/11/EC) Halogen Free per IEC-61249-2.21: 2003

RoHs Directive 2011/65/EU WEEE Directive (2012/12/EU)

Certificate of Compliance for Radioactive substances Certificate of Compliance for Asbestos

Certificate of Compliance for Ozone Depleting Substances, ODS

Certificate REACH SVHC

Certificate of Compliance RoHS EN CoC

Table 1

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Description

10m Ohms 1% 7W

ZX122S1AP package includes:

Part number ZX122S1AP ZX00BC2PH30

PCB Edge Key A

J2 Key A

Quantity Description

M.2 PCISIG Socket 1 power measurement module

12 30AWG Bare Copper wire to pin header wire assembly

ZX00BC2PH30 site page for ordering ZX00BC2PH30 wire assembly

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SPECIFIED DIMENSIONS ARE INCHES (MM). ROHS COMPLIANT

ASSEMBLY DRAWING

ITEM: ZX122S1AP

PCISIG M.2 NGFF Socket 1 Key A passive DESCRIPTION:

power measurement module CHECKED: DRAWN:

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SHEET: 1 OF 3

Current Sense resistors: The current sense resistors may be removed if external electronic

load, eLoad, is used. eLoad test equipment may be applied to ZX122S1AP for power supply characterization, test and measurements. Eload suppliers: BK Precision, Chroma, Instek, Kikusui and more

Signal assignments: Table 2 exhibits the routed M.2 PCISIG signals on the ZX122S1AP module.

Please note: Table 2 represents only the PCISIG M.2 Socket 1 Key A power supply and the assigned GND, PCISIG M.2 reference ground, signal assignments for "Socket 1 Key A" applications.

Ground / Exposed Copper:

All of the PCISIG M.2 GND, reference ground, signals are connected to each other along with the 2 inner GND planes. In addition; the exposed copper on the ZX122S1AP is the module's GND for purpose of rework and probing purpose.

PCISIG M.2 signals:

ZX122S1AP passes through all PCISIG M.2 signals (excluding the power supply rails . All traces are 50 Ohms impedance controlled. ZX122S1AP passes through the reserved "NC" No Connect signals as well.

Application: Bringup, testing, emulation, development, modular design evaluations

M.2 PCISIG Socket power supply test characterization SDIO SSD SATA WWAN DP WIFI GPS GYRO Compass BT FM sensor module Socket 1 Add-in Card Key A-E, Socket 1 DisplayPort Key A, Socket 1 SDIO Key E Socket 2 WWAN Key C, Socket 2 PCIe-based SSD Key B-M, Socket 2 SATA-based SSD Key B-M Socket 2 PCle / USB 3.1 Gen1-Based WWAN Key B , Socket2 PCle-Based WWAN Key B Socket 2 USB3.1 Gen1-based WWAN Key B, Socket 2 SSIC WWAN Key B

Mates with: Any standard M.2 NGFF PCISIG connector on host and device Key A

Socket 3 PCIe-based Key M, Socket 3 SATA-based Key M

TE 2199125 2199119 2199230 2199133 JAE SM3ZS067

Bellwether: SD-80148 SD-80149 SD-80152 SD-80159 Amphenol

Module Insertion, Removal process:

In order to avoid any mechanical stress or damage to ZX122S1AP, please follow the below listed guidelines for insertion and removal process:

- 1- Move the Module against the housing chamber, see figure 1
- 2- Rotate module to 25°, insert it until the module surface reaches the ramp, figure 2, 3
- 3- Rotate the module to horizontal position, see figure 4
- 4- Fix the module by screw, see figure 5

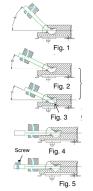




Figure 4 – Typical application - Rx, Ry: Current sense resistors

Table 2 – PCISIG M.2 Socket 1 Kev A

Please note: Table 2 represents only the PCISIG M.2 Socket 1 Key A power supply and the assigned GND, PCISIG M.2 reference ground, signal assignments for "Socket 1 Key A" applications.

Socket 1 Key A						
_	PC	PCISIG M.2 conne				
Signal	D:	ZX122S1AP			D:	Signal
	Pin	Label1		Label1	Pin	-
3.3 V	74	R	EP ²		75	GND
3.3 V	72			69	GND	
GND	36	EP ²			63	GND
GND	30				69	GND
GND	24				63	GND
GND	18				57	GND
ADD-IN CARD KEY A	14			FP ²	51	GND
	12				45	GND
	10				39	GND
	8				57	GND
3.3 V	4	- R1			33	GND
3.3 V	2				29	GND
					51	GND
					23	GND
				Ep2	15	ADD-IN CARD KEY A
					13	
					11	
					9	
					7	GND
				ī	1	GND

ZEBAX TECHNOLOGIES SANTA CRUZ, CA U.S.A (831) 2 2 2 - 0717 WWW.ZEBAX.COM ASSEMBLY DRAWING SPECIFIED DIMENSIONS ARE INCHES (MM). ITEM: ZX122S1AP ROHS COMPLIANT PCISIG M.2 NGFF Socket 1 Key A passive DESCRIPTION: power measurement module CHECKED:

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PCISIG M.2 NGFF Socket 1 Key A passive power measurement module - Page 3 of 3 **Product Name: ZX122S1AP**

Typical Application: ZX122S1AP is designed for purpose of PCISIG M.2 power supply characterization, test and debug at full connector's

bandwidth. It provides onboard current sense resistors where scope probe could be utilized for measuring characterization data for qualifying the host or device functional behavior. Additionally, the current sense resistors may be replaced by eLoad for transient and dynamic load throttling. Below are few suggestions in respect to proper power supply measurements using ZX122S1AP module:

Scope Probe wire Installation:

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Utilize the supplied ZX00BC2PH30 bare copper to pin wire assembly whenever possible - Based on availability of type of scope + probing options, install probe wire as listed below

- 1- It is recommended to keep the +probe wire length at 0.5" (1.2cm) long.
- 2- In order to avoid ground loop problems, please use the shortest Ground probe wire interfacing to the nearest GND reference. ZX122S1AP provides several exposed copper test points for probing purpose.
- 3- Ensure scope probe's bandwidth is set at 20MHz Certain tests require full scope + scope probe bandwidth; however, industry standard is 20MHz bandwidth for power supply test and measurements.
- 3- Both Keysight as well as Tektronix offer variety of single ended as well as differential probes along with their accessories, below are few probes from each vendor:
 - a) Keysight differential probe or similar N2795A, N2796A, 1168V, 1134B along with E2677B differential Solder-in probe, N5426A ZIF Tip, N2884A Fine Wire ZIF Tip and more - See the figure "probe head accessories".
 - b) Tektronix offers several single-ended as well as differential probes such as: P6243, P6245, P6248, P6246, P6247 or any TP1500, TAP2500, TAP3500, TAP4000, P7240 of TDP7000 series or equivalent
- 4- Please follow your vendor's guideline in installation of probe wires & accessories.

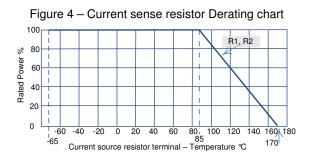
Power Rating: Onboard current sense resistors on ZX122S1AP module are designed for maximum power consumption per PCISIG M.2 specification operating within -65 ℃ to 85 ℃ temperature range. The current sense resistor's power rating will degrade at above 85 ℃ test environment. It is highly recommended to utilize external cooling fan if your design expects to exceed maximum current via each PCISIG M.2 pin (0.5A per pin) at above 85 °C test environment.

> The onboard current sense resistors operate at 100% listed power ratings (see Table 1) within temperature range: R1, R2: -65 °C \leq operating temperatures \leq 85 °C with tolerance = \pm 1%

The onboard current sense resistors **power ratings** derail at **above** 85 ℃. Figure 4 exhibits the current sense resistors derating curve. Current sense resistors rated power; $P = VI = I^{**}2 \times R$ where I is the maximum current for the listed resistor value R

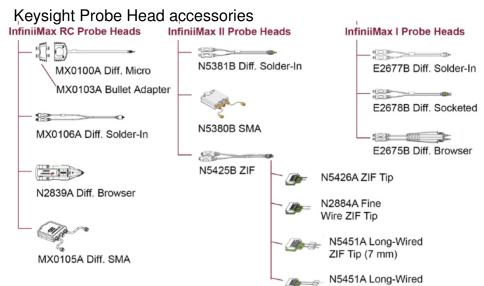
Below are few suggestions, if your test & measurement environment falls ≥ +85 °C temperature range:

- 1- Apply cooling fan where the current sense resistor's terminal blocks are measured at 85 °C Please note The ZX122S1AP module design provides heatsink solution to the onboard current sense resistors via inner layers thermal distribution method.
- 2- Replace the onboard current sense resistors with lower values (similar footprint), resulting at higher power ratings at ≥ 85 °C test environment.
- 3- Replace onboard current sense resistors with eLoad (electronic Load Board / System) eLoad system resides outside of test chamber, therefore it is not subject to temperature degradation.



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ITEM: ZX122S1AP

PCISIG M.2 NGFF Socket 1 Key A passive **DESCRIPTION:**

power measurement module CHECKED:

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REVISSION: 1.0

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